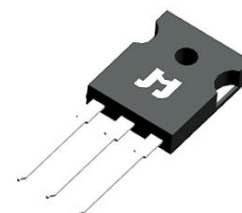


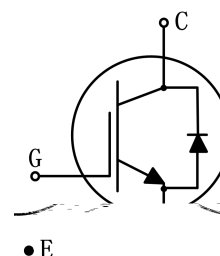
- $V_{CE}=650V$
- $I_C=50A@T_C=100$
- $V_{CE(sat)}=1.7V$

TO-247i

- Trench and field-stop technology.
- Easy parallel switching capability.



- High efficiency for inverters.
- High ruggedness performance.
- RoHS compliant.



- PFC applications
- Welding machines

Type	Marking	Package	Packaging Method
JJT50N65UK	T5065UK	TO-247i	Tube



V_{CES}	Collector-emitter voltage	650	V
V_{GES}	Gate-emitter voltage	± 20	V
I_C	Continuous collector current ($T_C=25^\circ\text{C}$)	100	A
	Continuous collector current ($T_C=100^\circ\text{C}$)	50	A
I_{CM}	Pulsed collector current, t_p limited by T_{vjmax}	200	A
I_F	Diode continuous forward current ($T_C=100^\circ\text{C}$)	30	A
I_{FM}	Diode maximum current, t_p limited by T_{vjmax}	60	A
P_{tot}	Power dissipation ($T_C=25^\circ\text{C}$)	230	W
	Power dissipation ($T_C=100^\circ\text{C}$)	115	W
T_{vj}	Operating junction temperature range	-40 to +175	
T_{stg}	Storage temperature range	-55 to +150	

$R_{th(j-c)}$	Thermal resistance, junction to case for IGBT	-	0.65	K/ W
$R_{th(j-c)}$	Thermal resistance, junction to case for Diode	-	1.3	K/ W
$R_{th(j-a)}$	Thermal resistance, junction to ambient	-	40	K/ W



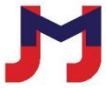
($T_{vj}=25$ unless otherwise specified)

Static characteristics

BV_{CES}	Collector-emitter breakdown voltage	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
I_{CES}	Collector-emitter leakage current	$V_{CE}=650V, V_{GE}=0V$	-	-	50	μA
I_{GES}	Gate leakage current, forward	$V_{GE}=20V, V_{CE}=0V$	-	-	100	nA
	Gate leakage current, reverse	$V_{GE}=-20V, V_{CE}=0V$	-	-	-100	nA
$V_{GE(th)}$	Gate-emitter threshold voltage	$V_{GE}=V_{CE}, I_C=1mA$	5.1	5.4	5.7	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$V_{GE}=15V, I_C=50A$	-	1.7	-	V
		$V_{GE}=15V, I_C=50A, T_{vj}=175$	-	2.1	-	V

Dynamic characteristics

C_{ies}	Input capacitance	$V_{CE}=30V$ $V_{GE}=0V$ $f=1MHz$	-	3860	-	pF
C_{oes}	Output capacitance		-	170	-	pF
C_{res}	Reverse transfer capacitance		-	30	-	pF
Q_g	Total gate charge	$V_{CC}=520V$ $V_{GE}=15V$ $I_C=50A$	-	120	-	nC



$t_{d(on)}$

Turn-on delay time

$V_{CC}=400V$

$V_{GE}=0/15V$



($T_{vj}=25$ unless otherwise specified)

V_F	Diode forward voltage	$I_F=50A$	2.0	2.3	2.6	V
		$I_F=50A, T_{vj}=175$	-	1.9	-	V
t_{rr}	Diode reverse recovery time	$V_R=400V$ $I_F=50A$ $di_F/dt=-450A/\mu s$	-	78	-	ns
I_{rrm}	Diode peak reverse recovery current		-	15	-	A
Q_{rr}	Diode reverse recovery charge		-	511	-	nC
t_{rr}	Diode reverse recovery time	$V_R=400V$ $I_F=50A$ $di_F/dt=-450A/\mu s$ $T_{vj}=175$	-	126	-	ns
I_{rrm}	Diode peak reverse recovery current		-	26	-	A
Q_{rr}	Diode reverse recovery charge		-	2163	-	nC

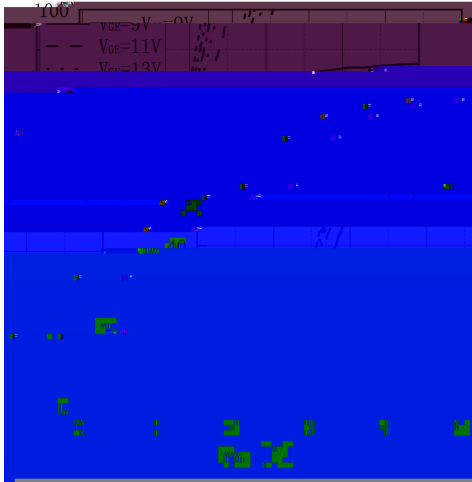


Fig 1. Typical output characteristic ($T_{vj}=25^\circ\text{C}$)

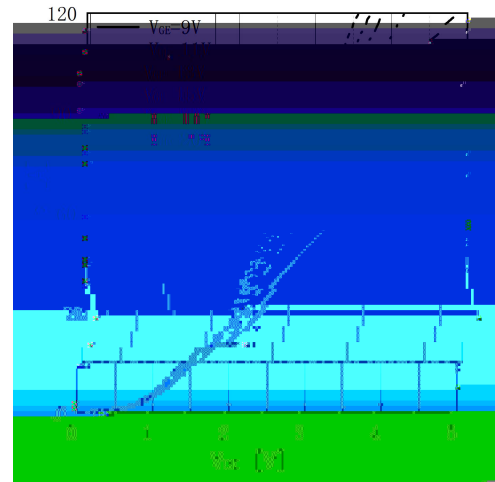


Fig 2. Typical output characteristic ($T_{vj}=175^\circ\text{C}$)

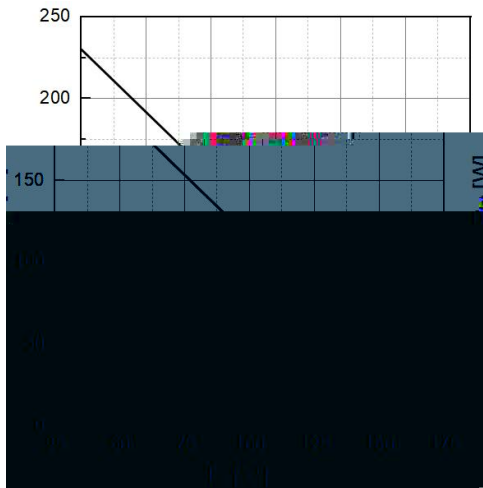


Fig 3. Power dissipation as a function of T_{vj}

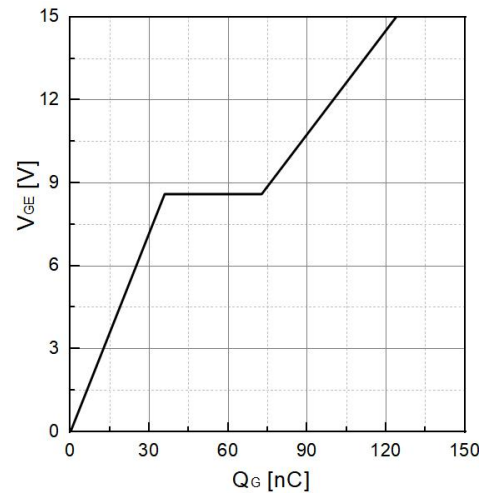


Fig 4. Typical Gate charge

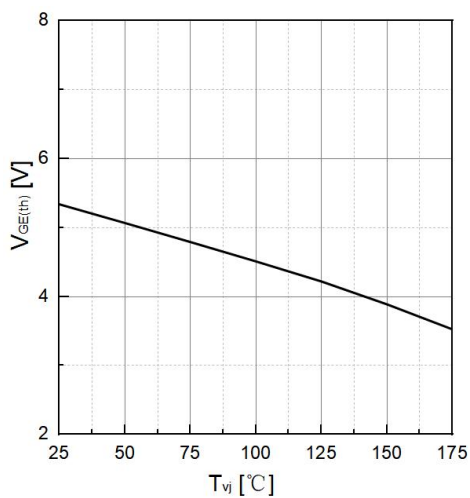


Fig 5. Typical $V_{GE(th)}$ as a function of T_{vj}
($I_C=1\text{mA}$)

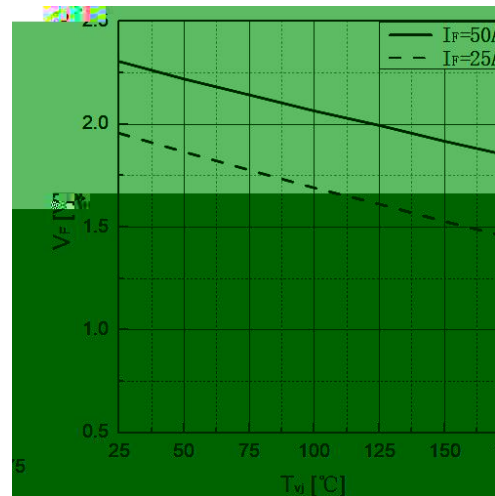


Fig 6. Typical V_F as a function of T_{vj}

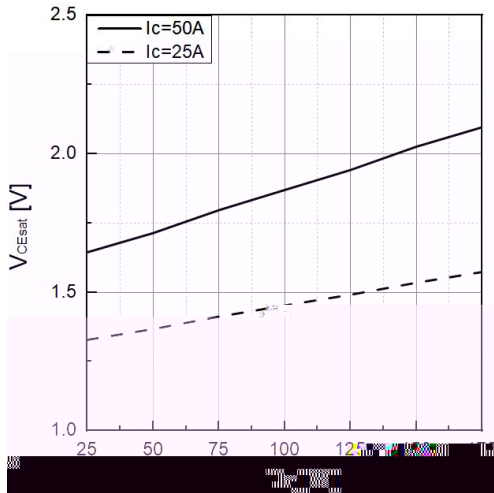


Fig 7. Typical V_{CEsat} as a function of T_{vj}

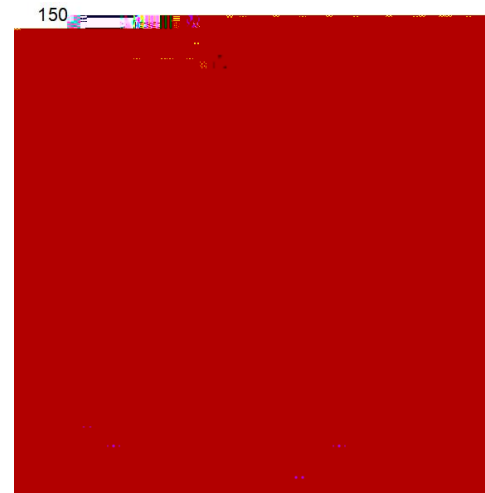


Fig 8. Typical I_F as a function of V_F

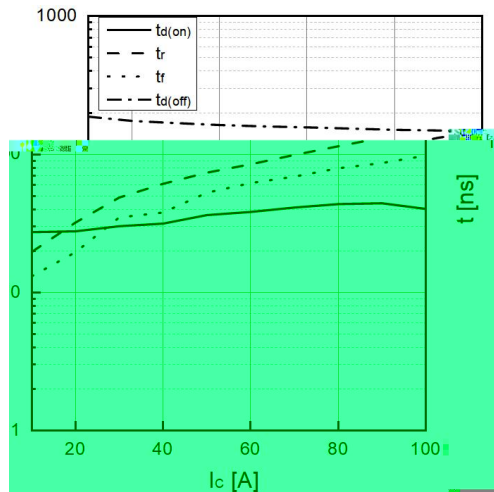


Fig 9. Typical switching time as a function of I_c

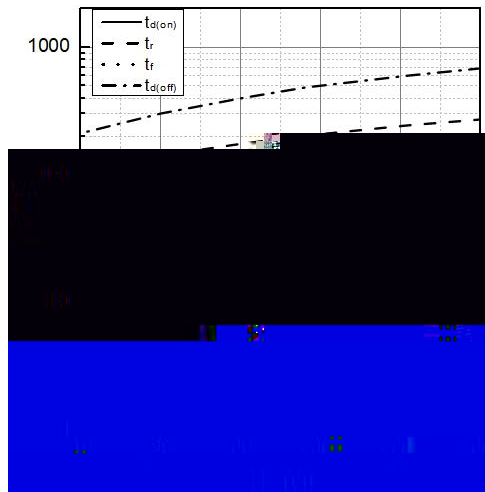


Fig 10. Typical switching times as a function of R_G

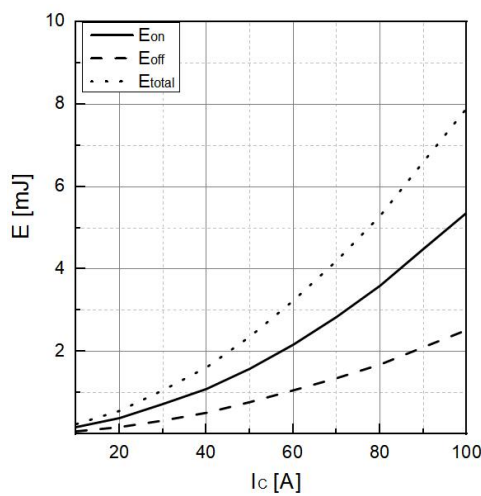


Fig 11. Typical switching energy losses as a function of I_c

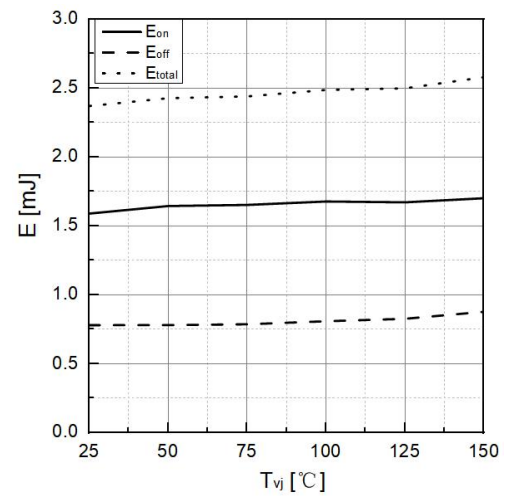


Fig 12. Typical switching energy losses as a function of T_{vj}

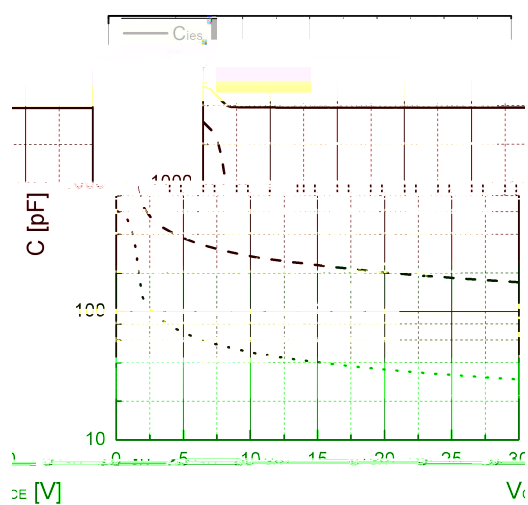
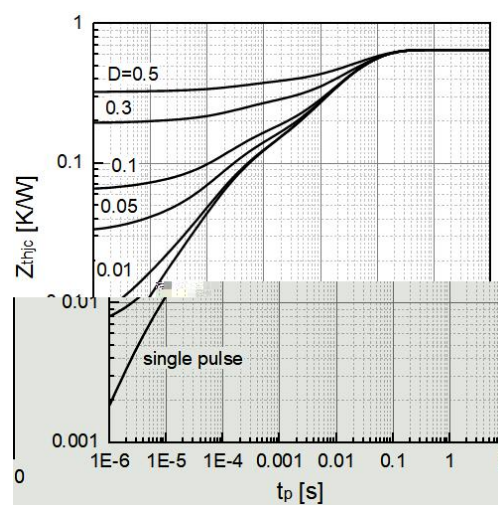
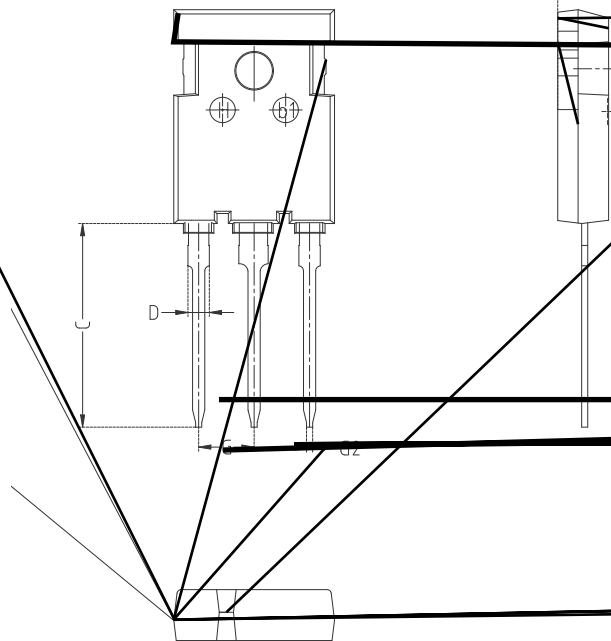


Fig 13. Typical capacitance as a function of V_{CE}
($f=1\text{MHz}$,





TO-247i



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	15.95	16.00	16.05	0.627	0.629	0.631
B	21.85	21.90	21.92	0.860	0.862	0.864
B1	5.15	5.20	5.25	0.202	0.204	0.206
B2	4.32	4.37	4.42	0.170	0.172	0.174
C	19.01	19.11	19.21	0.748	0.752	0.756
D	2.07	2.10	2.13	0.081	0.082	0.083
E	3.07	3.10	3.13	0.120	0.122	0.123
F	1.15	1.20	1.25	0.045	0.047	0.049
G	5.45REF			0.214REF		
G1	5.85	5.90	5.95	0.230	0.232	0.234
G2	-	0.60	-	-	0.023	-
G3	1.76	1.81	1.86	0.069	0.071	0.073
H	4.95	5.00	5.05	0.194	0.196	0.198
J	1.44	1.49	1.54	0.056	0.058	0.060
K	2.30	2.35	2.40	0.090	0.092	0.094
L	0.59	0.60	0.61	0.023	0.023	0.024
L1	1.85	1.90	1.95	0.072	0.074	0.076



Date	Revision	Changes
2025-05-17	Rev A.1.2	Update
2026-02-05	Rev 1.3	Update
2026-04-17	Rev 1.4	Update Thermal
2026-06-25	Rev 1.5	Add figure

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